ASSP For power supply applications

BIPOLAR

Power Supply Monitor

MB3771

DESCRIPTION

The Fujitsu MB3771 is designed to monitor the voltage level of one or two power supplies (+5 V and an arbitrary voltage) in a microprocessor circuit, memory board in large-size computer, for example.

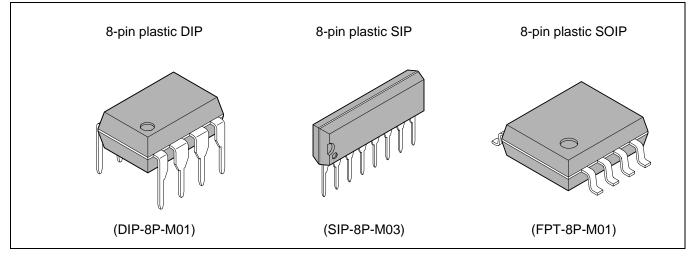
If the circuit's power supply deviates more than a specified amount, then the MB3771 generates a reset signal to the microprocessor. Thus, the computer data is protected from accidental erasure.

Using the MB3771 requires few external components. To monitor only a +5 V supply, the MB3771 requires the connection of one external capacitor. The level of an arbitrary detection voltage is determined by two external resistors. The MB3771 is available in an 8-pin Dual In-Line, Single In-Line Package or space saving Flat Package.

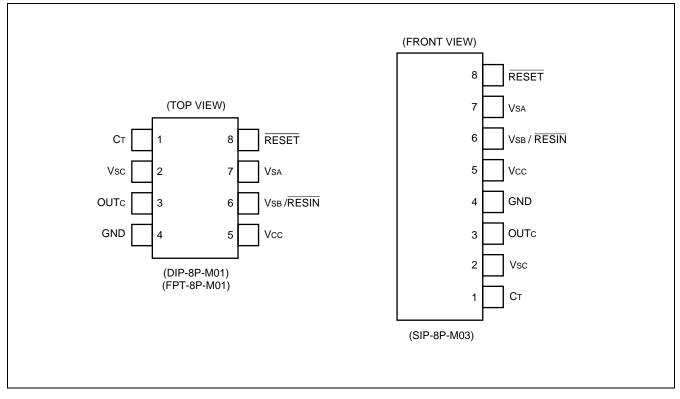
FEATURES

- Precision voltage detection (VsA = 4.2 V \pm 2.5 %)
- User selectable threshold level with hysterisis (VsB = 1.23 V \pm 1.5 %)
- Monitors the voltage of one or two power supplies (5 V and an arbitrary voltage, >1.23 V)
- · Usable as over voltage detector
- Low voltage output for reset signal (Vcc = 0.8 V typ.)
- Minimal number of external components (one capacitor min.)
- Low power dissipation (Icc = 0.35 mA typ., Vcc = 5 V)
- Detection threshold voltage has hysteresis function
- Reference voltage is connectable.

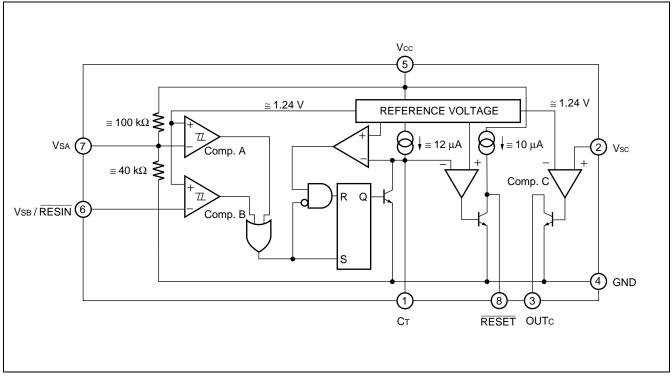
PACKAGES



■ PIN ASSIGNMENT



BLOCK DIAGRAM



■ FUNCTIONAL DESCRIPTIONS

Comparators Comp.A and Comp.B apply a hysteresis to the detected voltage, so that when the voltage at either the VsA or VsB pin falls below 1.23 V the RESET output signal goes to "low" level.

Comp. B may be used to detect any given voltage(Sample Application 3), and can also be used as a forced reset pin (with reset hold time) with TTL input (Sample Application 6).

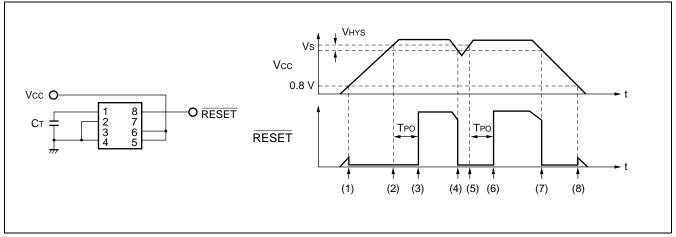
Note that if Comp.B is not used, the VSB pin should be connected to the Vcc pin (Sample Application 1).

Instantaneous breaks or drops in the power supply can be detected as abnormal conditions by the MB3771 within a 2 μ s interval. However because momentary breaks or drops of this duration do not cause problems in actual systems in some cases, a delayed trigger function can be created by connecting capacitors to the V_{SA} or V_{SB} pin (Sample Application 8).

Because the RESET output has built-in pull-up resistance, there is no need to connect to external pull-up resistance when connected to a high impedance load such as a CMOS logic IC.

Comparator Comp. C is an open-collector output comparator without hysteresis, in which the polarity of input/ output characteristics is reversed. Thus Comp. C is useful for over-voltage detection (Sample Application 11) and positive logic RESET signal output (Sample Application 7), as well as for creating a reference voltage (Sample Application 10).

Note that if Comp. C is not used, the Vsc pin should be connected to the GND pin (Sample Application 1).



■ FUNCTION EXPLANATION

- (1) When Vcc rises to about 0.8V, RESET goes low.
- (2) When Vcc reaches Vs +VHYs, CT then begins charging. RESET remains low during this time
- (3) $\overline{\text{RESET}}$ goes high when CT begins charging.

TPO \Rightarrow CT \times 10⁵ (Refer to CT pin capacitance vs. hold time)

(4) When Vcc level dropps lower then Vs, then RESET goes low and CT starts discharging.

(5) When Vcc level reaches Vs + VHYS, then CT starts charging.

In the case of voltage sagging, if the period from the time V_{CC} goes lower than or equal to V_S to the time V_{CC} reaches V_S +V_{HYS} again, is longer than t_{PI}, (as specified in the AC Characteristics), C_T is discharged and charged successively.

- (6) After TPO passes, and Vcc level exceeds Vs + VHYS, then RESET goes high.
- (7) Same as Point 4.
- (8) RESET remains low until Vcc drops below 0.8V.

ABSOLUTE	MAXIMUM	RATINGS
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Parameter	Symbol	Rat	ing	Unit
Falance	Symbol	Min.	Max.	
Power supply voltage	Vcc	-0.3	+20	V
	Vsa	-0.3	Vcc + 0.3 (< +20)	V
Input voltage	Vsb	-0.3	+20	V
	Vsc	-0.3	+20	V
Power dissipation	PD		200 (Ta ≤85 °C)	mW
Storage temperature	Tstg	-55	+125	°C

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Va	Value		
Falameter	Symbol	Min.	Max.	Unit	
Power supply voltage	Vcc	3.5	18	V	
	RESET	0	20	mA	
Output current	Ιουτς	0	6	mA	
Operating ambient temperature	Тор	-40	+85	°C	

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

■ ELECTRICAL CHARACTERISTICS

1. DC Characteristics

(Vcc = 5 V, Ta = + 25 °C)

Devementer	Cumhal	Conditions	Value			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Power supply current	Icc1	$V_{SB} = 5 V, V_{SC} = 0 V$	—	350	500	μA
	Icc2	$V_{SB} = 0 V, V_{SC} = 0 V$		400	600	μA
	VSAL	Vcc –	4.10	4.20	4.30	V
Detection voltage	(DOWN)	Ta = $-40 \degree C$ to $+85 \degree C$	4.05	4.20	4.35	V
Delection voltage	VSAH (UP)	Vcc	4.20	4.30	4.40	V
	V SAH (UP)	Ta = $-40 \degree C$ to $+85 \degree C$	4.15	4.30	4.45	V
Hysterisis width	Vhysa	—	50	100	150	mV
Detection voltage	Maa	Vsb -	1.212	1.230	1.248	V
Detection voltage	Vsв	Ta = $-40 \degree C$ to $+85 \degree C$	1.200	1.230	1.260	V
Deviation of detection voltage	ΔV_SB	Vcc = 3.5 V to 18 V	—	3	10	mV
Hysterisis width	VHYSB	—	14	28	42	mV
Innut ourront	Іінв	V _{SB} = 5 V	—	0	250	nA
Input current	IILB	V _{SB} = 0 V		20	250	nA
"H" level output voltage	Vohr	Ireset = $-5 \mu A$, VSB = 5 V	4.5	4.9		V
		Ireset = 3mA, Vsb = 0 V	—	0.28	0.4	V
Output saturation voltage	Volr	Ireset = 10mA, Vsb = 0 V	—	0.38	0.5	V
Output sink current	IRESET	Volr = 1.0 V, Vsb = 0 V	20	40		mA
CT charge current	Іст	Vsb = 5 V, Vct = 0.5 V	9	12	16	μA
	Інс	Vsc = 5 V	—	0	500	nA
Input current	lilc	Vsc = 0 V	—	50	500	nA
Detection voltage	Maa	—	1.225	1.245	1.265	V
Detection voltage	Vsc	Ta = $-40 \degree$ C to $+85 \degree$ C	1.205	1.245	1.285	V
Deviation of detection voltage	ΔVsc	Vcc = 3.5 V to 18 V		3	10	mV
Output leakage current	Іонс	Vонс = 18 V		0	1	μA
Output saturation voltage	Volc	Ioutc = 4 mA, Vsc = 5 V		0.15	0.4	V
Output sink current	Іоитс	Volc = 1.0 V, Vsc = 5 V	6	15		mA
Reset operation minimum supply voltage	Vccl	$V_{OLR} = 0.4 \text{ V}, \text{ Ireset} = 200 \mu\text{A}$	_	0.8	1.2	V

2. AC Characteristics

 $(V_{CC} = 5 \text{ V}, \text{ Ta} = +25 \text{ }^{\circ}\text{C}, \text{ C}_{T} = 0.01 \text{ } \mu\text{F})$

Parameter	Symbol	Conditions	Value			Unit
Farameter	Parameter Symbol Conditions	Conditions	Min.	Тур.	Max.	Unit
Vsa, Vsb input pulse width	t _{PI}	—	5.0	_		μs
RESET output pulse width	t _{PO}		0.5	1.0	1.5	ms
RESET rise time	tr	R∟ = 2.2 kΩ,		1.0	1.5	μs
RESET fall time	tr	C∟ = 100 pF	_	0.1	0.5	μs
	tPD*1	—	_	2	10	μs
Propagation delay time	t₽н∟*²	R∟ = 2.2 kΩ,		0.5		μs
	tplh*2	C∟ = 100 pF		1.0		μs

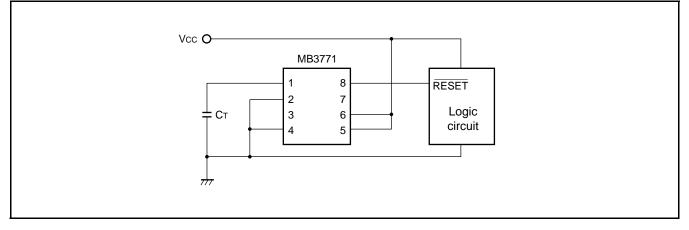
*1: In case of VSB termination.

*2: In case of Vsc termination.

■ APPLICATION CIRCUIT

1. 5V Power Supply Monitor

Monitored by $V_{\text{SA}}.$ Detection threshold voltage is V_{SAL} and V_{SAH}



2. 5V Power Supply Voltage Monitor (Externally Fine-Tuned Type)

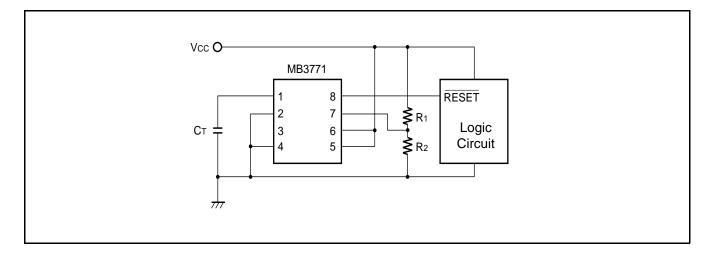
The VsA detection voltage can be adjusted externally.

Resistance R_1 and R_2 are set sufficiently lower than the IC internal partial voltage resistance, so that the detection voltage can be set using the ratio between resistance R_1 and R_2 . (See the table below).

• R₁, R₂ calculation formula (when R₁ << 100 kΩ, R₂ <<40 kΩ)

 $V_{SAL} \doteqdot (R_1 + R_2) \times V_{SB}/R_2 [V], V_{SAH} \doteqdot (R_1 + R_2) \times (V_{SB} + V_{HYSB})/R_2 [V]$

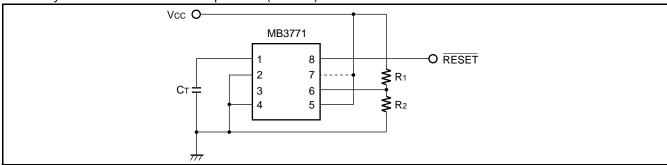
R 1 (kΩ)	R₂ (kΩ)	Detection voltage : VSAL (V)	Detection voltage : VSAH (V)
10	3.9	4.37	4.47
9.1	3.9	4.11	4.20



3. Arbitrary Voltage Supply Monitor

- (1) Case: Vcc \leq 18 V
 - Detection Voltage can be set by R1 and R2.
 Detection Voltage = (R1 + R2) × VSB/R2
 - Connect Pin 7 to Vcc when Vcc less than 4.45 V.
 - Pin 7 can be opened when $V_{\rm CC}$ greater than 4.45 V Power Dissipation can be reduced.

Note : Hysteresis of 28 mV at V_{SB} at termination is available. Hysteresis width dose not depend on ($R_1 + R_2$).

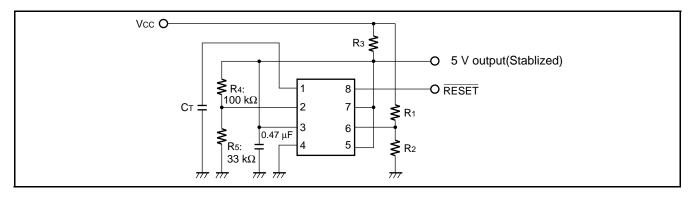


(2) Monitoring Vcc > 18 V

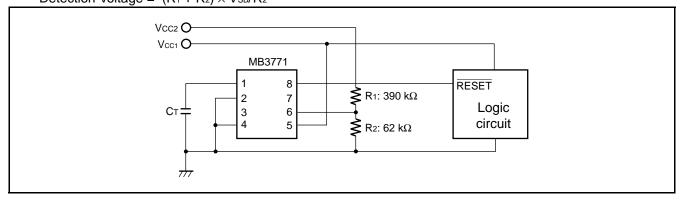
- Detection Voltage can be set by R1 and R2 Detection Voltage = (R1 + R2) × VsB/R2
- The RESET signal output is ÷ 0V (low level) and ÷ 5 V (high level). Vcc voltage cannot be output. Do not pull up RESET to Vcc.
- Changing the resistance ratio between R₄ and R₅ changes the constant voltage output, thereby changing the voltage of the high level RESET output. Note that the constant voltage output should not exceed 18 V.
- The 5 V output can be used as a power supply for control circuits with low current consumption.
- In setting the R₃ resistance level, caution should be given to the power consumption in the resistor. The table below lists sample resistance values for reference (using 1/4 Ω resistance).

Vcc (V)	Detection voltage (V)	RESET Output min. power supply voltage (V)	R 1 (Μ Ω)	R₂ (kΩ)	R₃ (k Ω)	Output Current (mA)
140	100	6.7	1.6	20	110	< 0.2
100	81	3.8	1.3	20	56	< 0.5
40	33	1.4	0.51	20	11	< 1.6

Values are actual measured values (using loute = 100 μA, Vole = 0.4 V). Lowering the resistance value of R₃ reduces the minimum supply voltage of the RESET output, but requires resistance with higher allowable loss.



- 4. 5 V and 12 V Power Supply Monitor (2 types of power supply monitor $V_{CC1} = 5 V$, $V_{CC2} = 12 V$)
 - + 5 V is monitored by VsA. Detection voltage is about 4.2 V
 - 12 V is monitored by V_{SB}. When R₁ = 390 kΩ and R₂ = 62 kΩ, Detection voltage is about 9.0 V.Generally the detection voltage is determined by the following equation.
 Detection Voltage = (R₁ + R₂) × V_{SB}/R₂



5. 5 V and 12 V Power Supply Monitor (RESET signal is generated by 5 V, Vcc1 = 5 V, Vcc2 = 12 V)

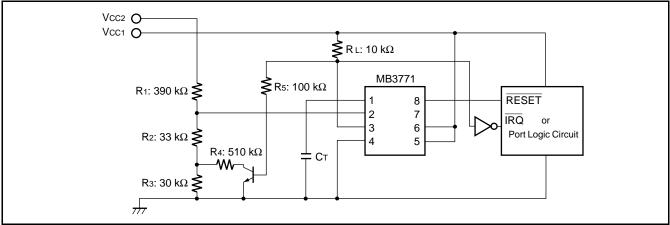
- 5 V is monitored by VsA, and generates RESET signal when VSA detects voltage sagging.
- 12 V is monitored by Vsc, and generates its detection signal at OUTc.
- The detection voltage of 12 V monitoring and its hysterisis is determined by the following equations.

Detection voltage = $\frac{R_1 + R_2 + R_3}{R_2 + R_3} \times V_{SC}$

(8.95 V in the circuit above)

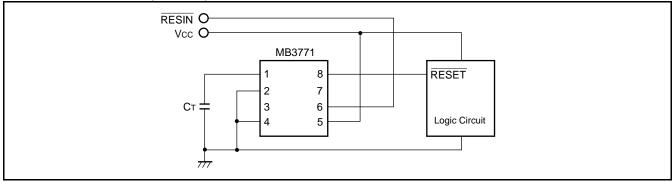
Hysterisis width =
$$\frac{R_1 (R_3 - R_3 // R_4)}{(R_2 + R_3) (R_2 + R_3 // R_4)} \times V_{SC}$$

(200 mV in the circuit above)



6. 5 V Power Supply Monitor with forced $\overline{\text{RESET}}$ input (Vcc = 5 V)

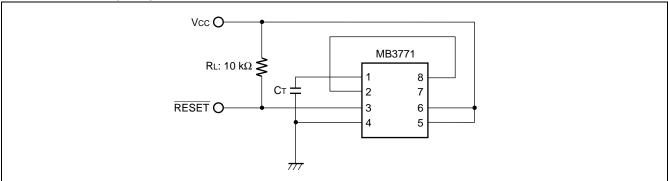
RESIN is an TTL compatible input.



7. 5 V Power Supply Monitor with Non-inverted RESET

In this case, Comparator C is used to invert RESET signal. OUTC is an open-collector output.

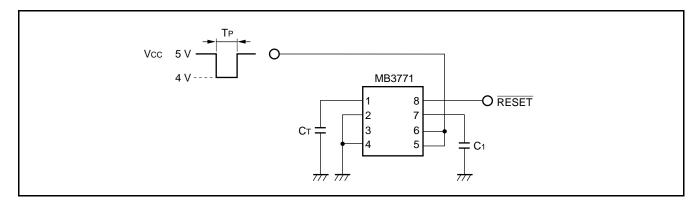
RL is used an a pull-up resistor.



8. Supply Voltage Monitoring with Delayed Trigger

When the voltage shown in the diagram below is applied at V_{CC}, the minimum value of the input pulse width is increased to 40 μ s (when C₁ = 1000 pF).

The formula for calculating the minimum value of the input pulse width [TPI] is: TPI [µs] = $4 \times 10^{-2} \times C_1$ [pF]

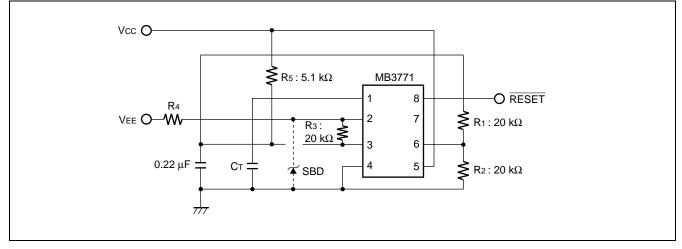


9. Dual (Positive/Negative) Power Supply Voltage Monitoring (Vcc = 5 V, VEE = Negative Power Supply)

Monitors a 5 V and a negative (any given level) power supply. R₁, R₂, and R₃ should be the same value. Detection Voltage = V_{SB} - V_{SB} × R₄/R₃ Example if V_{EE} = -5 V, R₄ = 91 k Ω

Then the detected voltage = -4.37 V

In cases where VEE may be output when Vcc is not output, it is necessary to use a Schottky barrier diode (SBD).

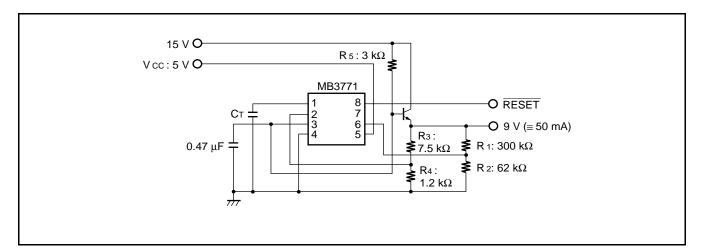


10. Reference Voltage Generation and Voltage Sagging Detection

(1) 9V Reference Voltage Generation and 5V/9V Monitoring

Detection Voltage = 7.2 V

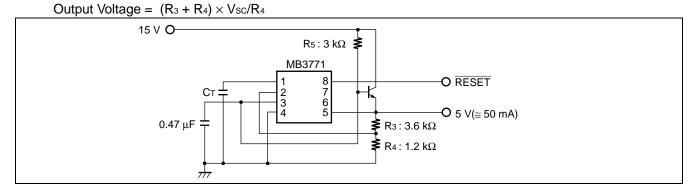
In the above examples, the output voltage and the detection voltage are determined by the following equations: Detection Voltage = $(R_1 + R_2) \times V_{SB}/R_2$



(2) 5 V Reference Voltage Generation and 5V Monitoring (No.1)

Detection Voltage = 4.2 V

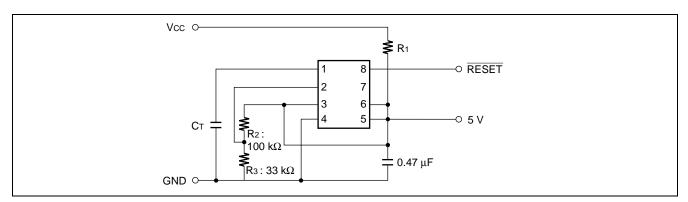
In the above examples, the output voltage and the detection voltage are determined by the following equations:



(3) 5 V Reference Voltage Generation and 5 V Monitoring (No. 2)

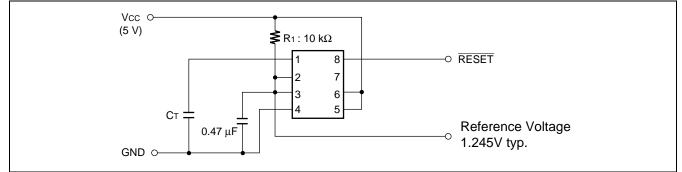
The value of R_1 should be calculated from the current consumption of the MB3771, the current flowing at R_2 and R_3 , and the 5 V output current. The table below provides sample resistance values for reference.

Vcc (V)	R1 (kΩ)	Output Current (mA)
40	11	< 1.6
24	6.2	< 1.4
15	4.7	< 0.6



(4) 1.245 V Reference Voltage Generation and 5 V Monitoring

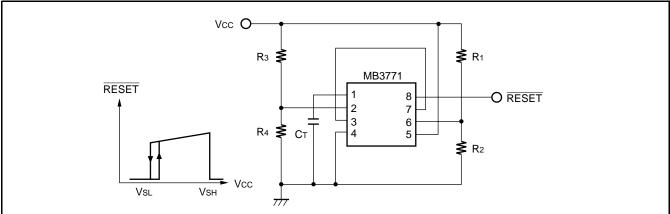
Resistor R₁ determines Reference current. Using 1.2 k Ω as R₁, reference current is about 2 mA.



11. Low Voltage and Over Voltage Detection (Vcc = 5 V)

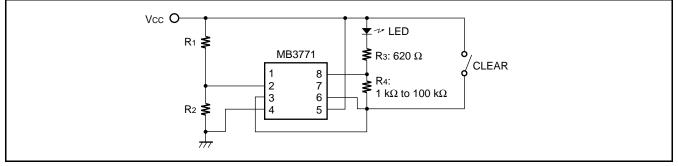
VsH has no hysteresis. When over voltage is detected, RESET is held in the constant time as well as when

low voltage is detected. $V_{SL} = (R_1 + R_2) \times V_{SB}/R_2$ $V_{SH} = (R_3 + R_4) \times V_{SC}/R_4$



12. Detection of Abnormal State of Power Supply System (Vcc = 5 V)

- This Example circuit detects abnormal low/over voltage of power supply voltage and is indicated by LED indicator. LED is reset by the CLEAR key.
- The detection levels of low/over voltages are determined by V_{SA} , and R_1 and R_2 respectively.



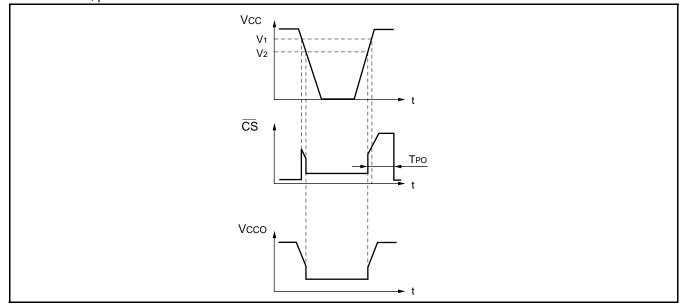
13. Back-up Power Supply System (Vcc = 5 V)

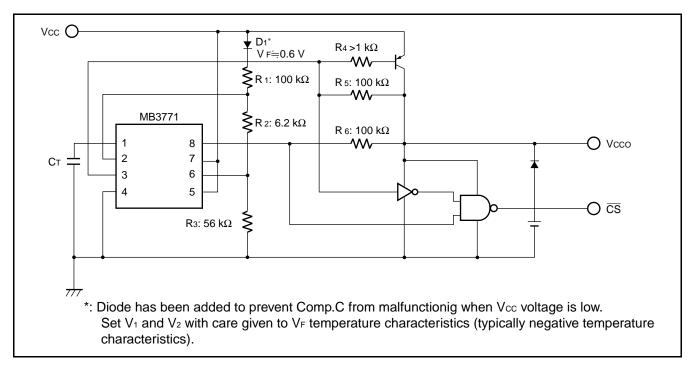
- Use CMOS Logic and connect VDD of CMOS logic with Vcco.
- The back-up battery works after CS goes high as $V_2 < V_1$.
- During tPO, memory access is prohibited.
- CS's threshold voltage V₁ is determined by the following equation: V₁ = V_F + $(R_1 + R_2 + R_3) \times V_{SB}/R_3$

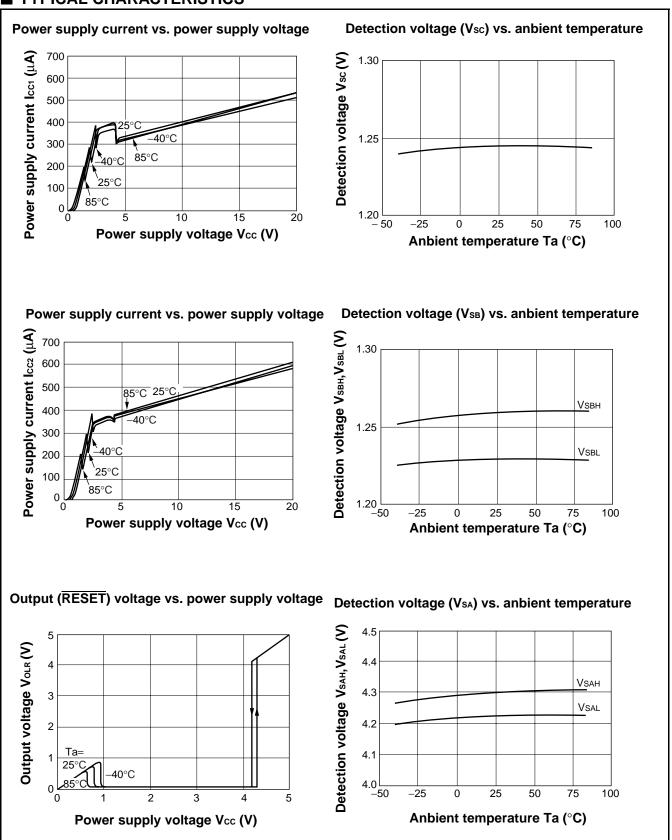
When V_1 is 4.45 V or less, connect 7 pin with Vcc.

- When V₁ is 4.45 V or more, 7 pin can be used to open.
- The voltage to change V₂ is provided as the following equation: $V_2 = V_F + (R_1 + R_2 + R_3) \times V_{SC}/(R_2 + R_3)$

However, please set V_2 to 3.5 V or more.





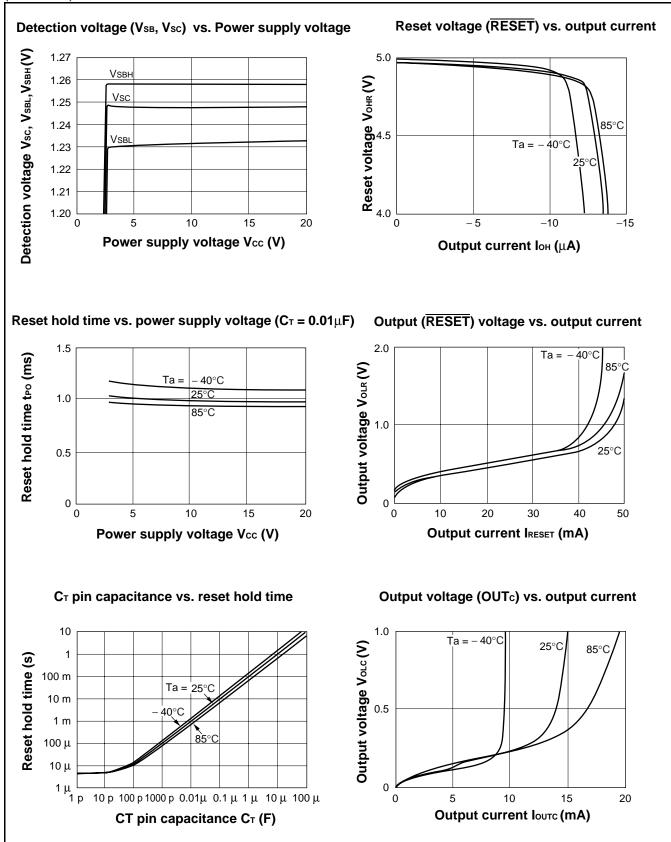


TYPICAL CHARACTERISTICS

(Continued)

MB3771

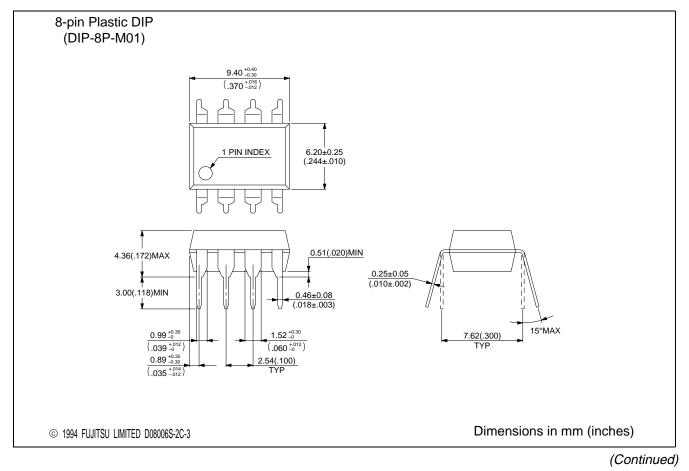




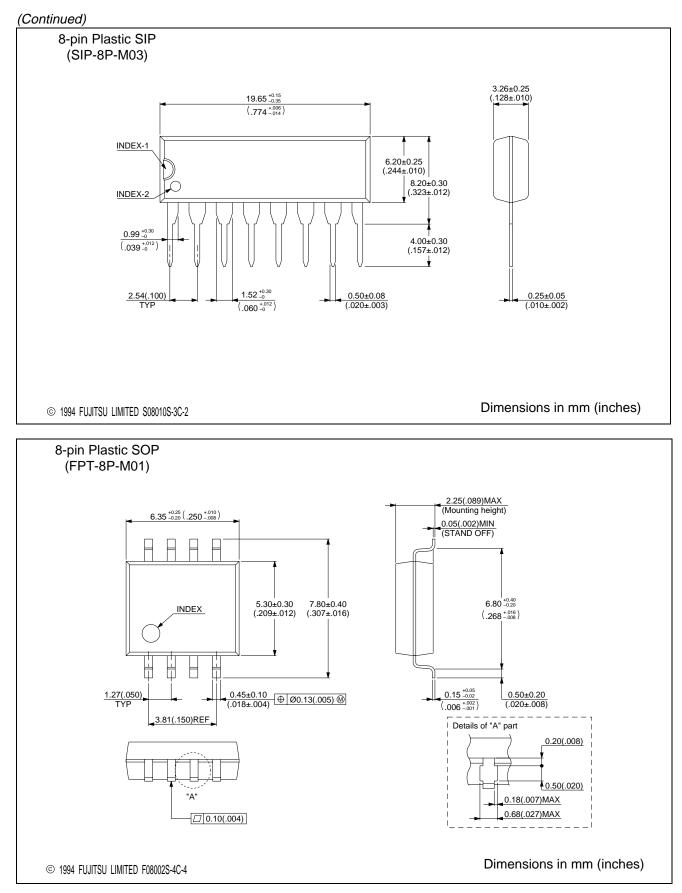
■ ORDERING INFORMATION

Part number	Package	Remarks
MB3771P	8-pin Plastic DIP (DIP-8P-M01)	
MB3771PS	8-pin Plastic SIP (SIP-8P-M03)	
MB3771PF	8-pin Plastic SOP (FPT-8P-M01)	

■ PACKAGE DIMENSIONS







MB3771

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